imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Wicrosemi POWER PRODUCTS GROUP

650V, 95A, $V_{CE(on)}$ = 1.9V Typical

Ultra Fast NPT - IGBT®

The Ultra Fast 650V NPT-IGBT[®] family of products is the newest generation of IGBTs optimized for outstanding ruggedness and best trade-off between conduction and switching losses.

Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant 💋

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

MAXIMUM RATINGS

All Ratings: $T_{c} = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Ratings	Unit
V_{ces}	Collector Emitter Voltage	650	V
V_{GE}	Gate-Emitter Voltage	±30	V
I _{C1}	Continuous Collector Current @ T _c = 25°C	208	
I _{C2}	Continuous Collector Current @ T _c = 110°C	100	А
I _{CM}	Pulsed Collector Current $^{\textcircled{1}}$	400	
SCWT	Short Circuit Withstand Time: V_{ce} = 325V, V_{ge} = 15V, T_c =125°C	10	μs
P _D	Total Power Dissipation @ $T_c = 25^{\circ}C$	892	W
T_,T _{stg}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	C

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage ($V_{GE} = 0V$, $I_{C} = 250uA$)	650			
V _{GE(TH)}	Gate Threshold Voltage ($V_{CE} = V_{GE}$, $I_{C} = 2.5$ mA, $T_{j} = 25$ °C)	3.5	5.0	6.5	Volts
V _{CE(ON)}	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 95A, T_{j} = 25°C)		1.9	2.4	
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{C} = 95A, T_{j} = 125°C)		2.4		
	Collector-Emitter On Voltage (V_{GE} = 15V, I_{c} = 190A, T_{j} = 25°C)		2.6		
I _{CES}	Collector Cut-off Current (V _{CE} = 650V, V _{GE} = 0V, T _j = 25°C) ⁽²⁾		10	250	μA
	Collector Cut-off Current (V _{CE} = 650V, V _{GE} = 0V, T _j = 125°C) ⁽²⁾		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.







DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C _{ies}	Input Capacitance	Capacitance		5910		
C _{oes}	Output Capacitance	V _{GE} = 0V, V _{CE} = 25V		1150		pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz		565		
V_{GEP}	Gate to Emitter Plateau Voltage	Gate Charge	1	7.5		V
Q _g ③	Total Gate Charge	V _{GE} = 15V		312	420	nC
Q _{ge}	Gate-Emitter Charge	V _{CE} = 325V		42	55	
Q _{gc}	Gate- Collector Charge	I _c = 95A		154	210	
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)	1	29		ns
t,	Current Rise Time	V _{cc} = 433V		76		
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		226		
t _r	Current Fall Time	I _c = 95A		84		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3\Omega^{4}$		3120	4680	μJ
E _{off}	Turn-Off Switching Energy	T = +25°C		2550	3830	
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)	1	29		ns
t,	Current Rise Time	V _{cc} = 433∨		76		
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		246		
t _r	Current Fall Time	I _c = 95A		90		
E _{on2} 5	Turn-On Switching Energy	$R_{g} = 4.3\Omega^{(4)}$		3155	4730	1
E _{off}	Turn-Off Switching Energy	T_ = +125°C		2745	4120	μJ

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
R _{ejc}	Junction to Case Thermal Resistance			.14	°C/W
R _{eja}	Junction to Ambient Thermal Resistance			40	
W _T	Package Weight		.22		oz
			6.2		g

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width < $380\mu s$, duty cycle < 2%.

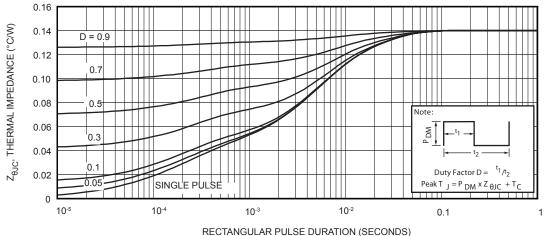
3 See Mil-Std-750 Method 3471.

 $\ \ \, {\sf A} \quad {\sf R}_{\sf G} \ \, \text{is external gate resistance, not including internal gate resistance or gate driver impedance.} \ \ \, ({\sf MIC4452}) \ \ \,$

5 E_{on2} is the energy loss at turn-on and includes the charge stored in the freewheeling diode.

6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

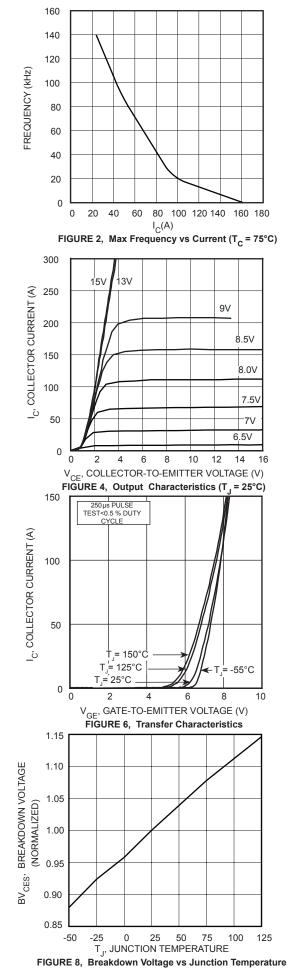
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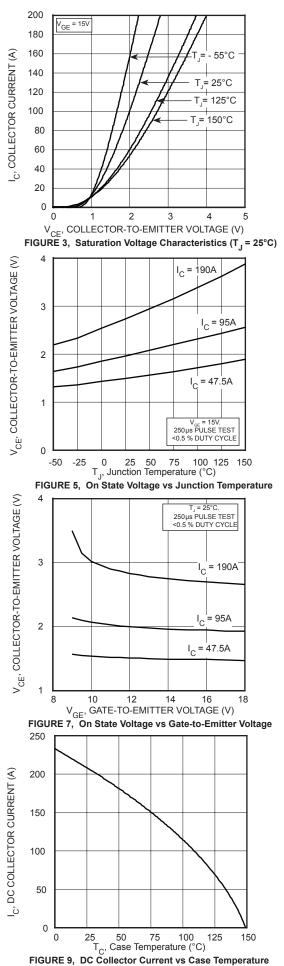


RECIANGULAR PULSE DURATION (SECONDS) Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

TYPICAL PERFORMANCE CURVES

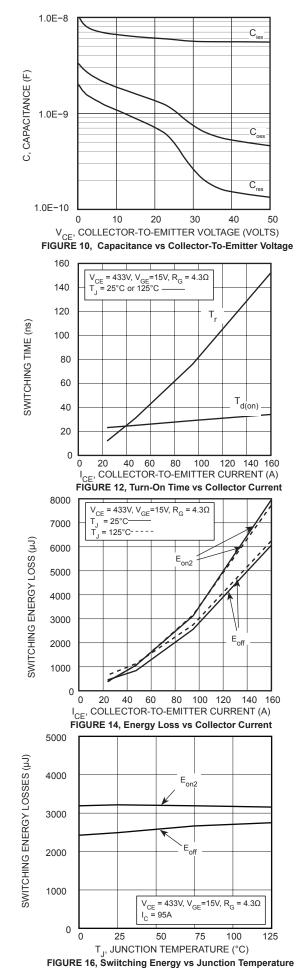
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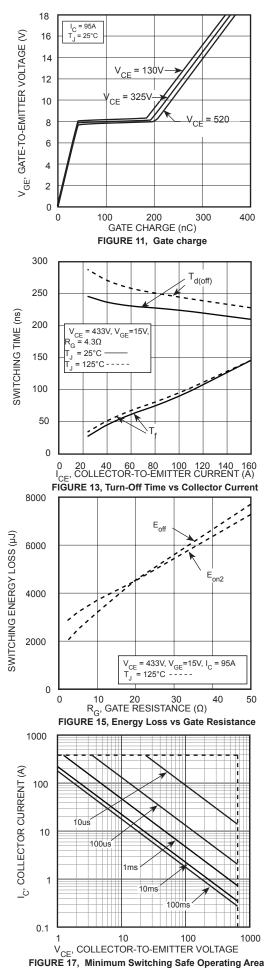


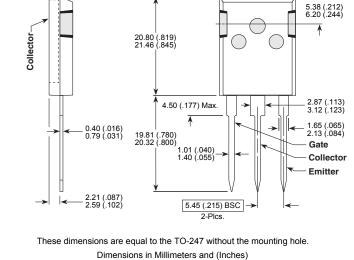


TYPICAL PERFORMANCE CURVES

APT95GR65B2







T-MAX[™] (B2) Package Outline

. 15.49 (.610) 16.26 (.640)

¥

4.69 (.185) 5.31 (.209)

1.49 (.059) 2.49 (.098)

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